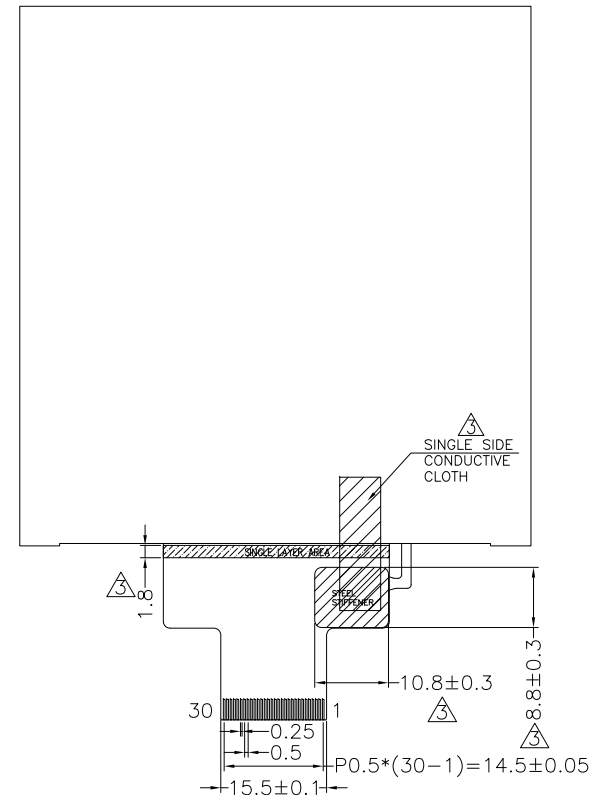


BACKLIGHT CIRCUIT DIAGRAM



PIN ASSIGNMENT	
PIN	SYMBLE
1	LEDA
2	LEDK1
3	LEDK2
4	VCI
5	IOVCC
6	RESET
7	TE
8	PWM
9	GND
10	DOP
11	DON
12	GND
13	D1P
14	D1N
15	GND
16	CLKP
17	CLKN
18	GND
19	D2P
20	D2N
21	GND
22	D3P
23	D3N
24	GND
25	NC
26	NC
27	NC
28	NC
29	NC
30	NC

NOTES:

1. DISPLAY TYPE: TFT / TRANSMISSIVE/ NORMALLY BLACK.
2. OPERATING VOLTAGE: VCI=3.3V.
3. VIEWING DIRECTION: FULL VIEWING ANGLE.
4. DRIVER IC: HX8394F.
5. OPERATING TEMP.: -20°~70°.
6. STORAGE TEMP.: -30°~80°.
7. BACKLIGHT: 8-CHIP WHITE LED, IF=40mA, VF=12.8V±0.8V.
8. SURFACE LUMINANCE: 350CD/M²(TYP.).
9. THE SINGLE LAYER AREA OF FPC IS BENDABLE AND THE BENDING RADIUS MUST BE NOT LESS THAN 1.5mm.
10. GENERAL TOLERANCE: ±0.2mm.
11. ROHS COMPLIANT.



MULTI-INNO TECHNOLOGY CO., LTD.

DRAWN BY:	RITA	2018.09.21	SCALE : 1/1	MODULE P/N:
CHECKED BY:			UNIT:	MIO400KT-1
APPROVED BY:			mm	DESCRIPTION:
VERSION NO:	03			TFT MODULE

VER.	REVISED DESCRIPTION	REVISER	DATE
03	ADD DIMENSION OF FPC SINGLE LAYER AREA. CORRECT THE DIMENSIONS OF FPC-STEEL STIFFENER. MODIFY THE DRIVER IC. CORRECT THE PIN30 DEFINITION.	RITA	2020.08.26
02	CORRECT THE PIN30 DEFINITION.	RITA	2018.11.05
01	FIRST ISSUE	RITA	2018.09.21